
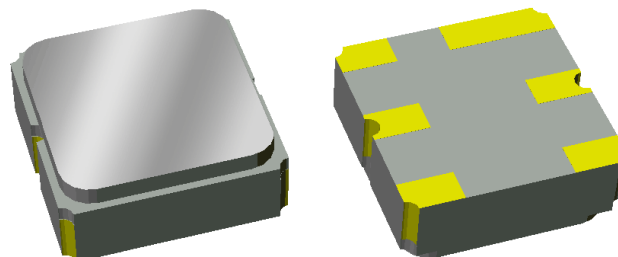


### Features

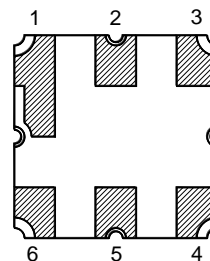
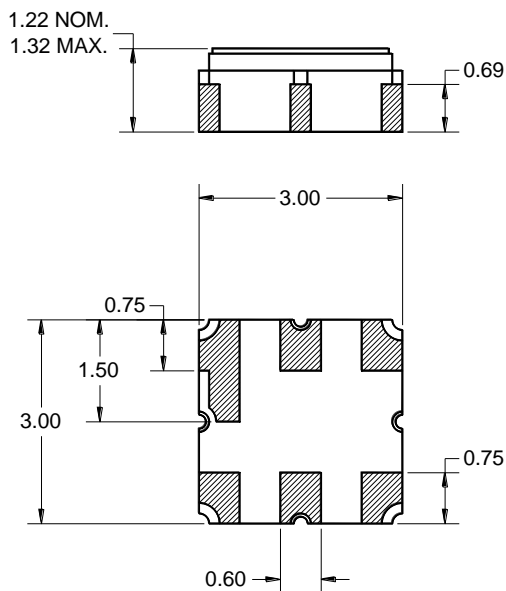
- For Base Stations applications
- Usable bandwidth 35 MHz
- Low loss
- Single-ended operation
- Ceramic Surface Mount Package (SMP)
- Small Size
- Hermetic
- RoHS compliant (2002/95/EC), Pb-free 



### Pin Configuration

Surface Mount 3.00 x 3.00 x 1.22 mm  
SMP-12

Bottom View



Pin No.	Description
2	Input
5	Output
1,3,4,6	Case ground

Dimensions shown are nominal in millimeters  
All tolerances are  $\pm 0.15$ mm except overall  
length and width  $\pm 0.10$ mm

Body:  $Al_2O_3$  ceramic  
Lid: Kovar, Ni plated  
Terminations: Au plating 0.5 - 1.0 $\mu$ m,  
over a 2 - 6 $\mu$ m Ni plating

**Electrical Specifications <sup>(1)(2)</sup>**

Operated Temperature Range: <sup>(3)</sup> -30 to +85 °C

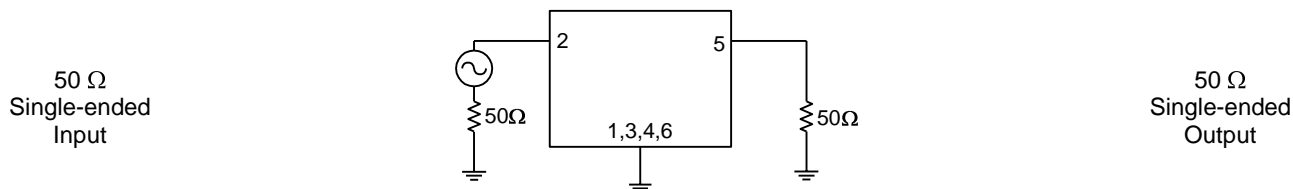
Parameter <sup>(4)</sup>	Minimum	Typical <sup>(5)</sup>	Maximum	Unit
<b>Center Frequency</b>	-	1445.4	-	MHz
<b>Maximum Insertion Loss</b> 1427.9 – 1462.9 MHz	-	1.25	2.5	dB
<b>Amplitude Variation</b> 1427.9 – 1462.9 MHz	-	0.4	1.2	dB p-p
1427.9 – 1462.9 MHz (Over any 5 MHz range)	-	0.3	0.8	dB p-p
<b>VSWR</b> 1427.9 – 1462.9 MHz	-	1.7	2	-
<b>Phase Ripple</b> 1427.9 – 1462.9 MHz	-	12.0	35	deg
<b>Absolute Delay</b> 1427.9 – 1462.9 MHz	-	14.0	35	ns
<b>Group Delay Variation</b> 1427.9 – 1462.9 MHz	-	11.0	30	ns p-p
<b>Relative Attenuation <sup>(6)</sup></b>				
60 – 120 MHz	30	41.6	-	dB
300 – 500 MHz	24	30.0	-	dB
1240 – 1280 MHz	24	28.5	-	dB
1390 – 1407.9 MHz	10	16.9	-	dB
1495.9 – 1521 MHz	20	23.3	-	dB
1600 – 1710 MHz	25	31.2	-	dB
2140 – 2180 MHz	32	38.8	-	dB
3200 – 4000 MHz	5	8.3	-	dB
<b>Source Impedance (single-ended) <sup>(7)</sup></b>	-	50	-	Ω
<b>Load Impedance (single-ended) <sup>(7)</sup></b>	-	50	-	Ω

**Notes:**

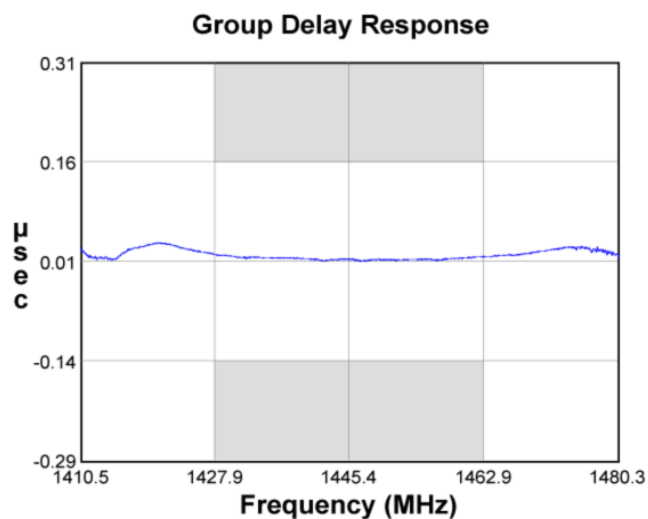
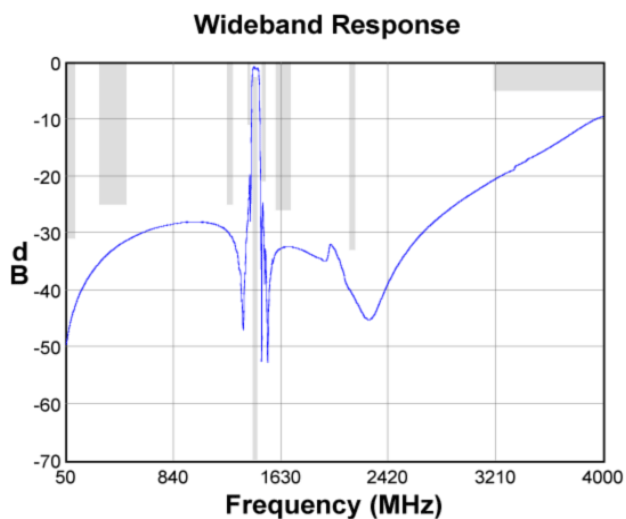
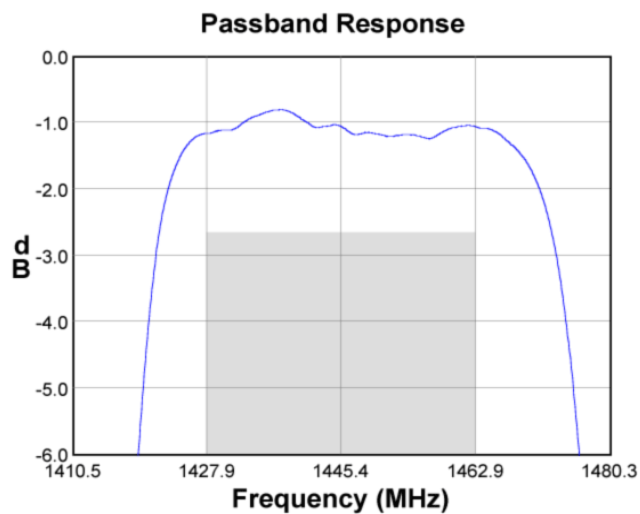
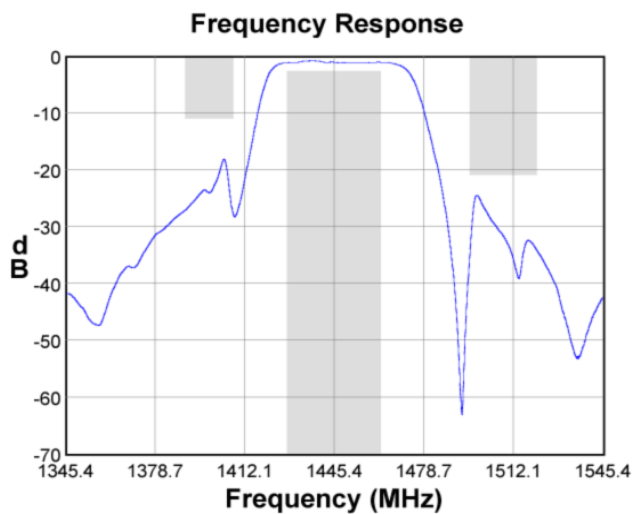
1. All target specifications are based on TriQuint test circuit shown below
2. All target specifications represent a design goal and not a guarantee until the design is finalized and a datasheet is issued
3. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
4. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
5. Typical values are based on average measurements at room temperature
6. Attenuation relative to Maximum Insertion Loss
7. This is the optimum impedance In order to achieve the performance shown

**Test Circuit:**

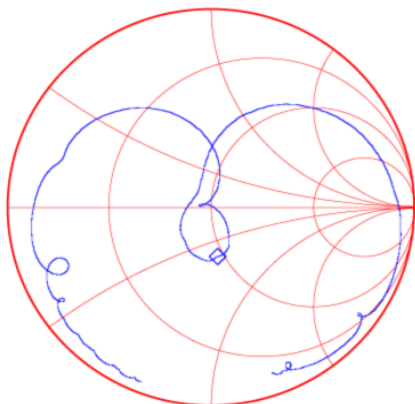
Actual matching values may vary due to PCB layout and parasitics



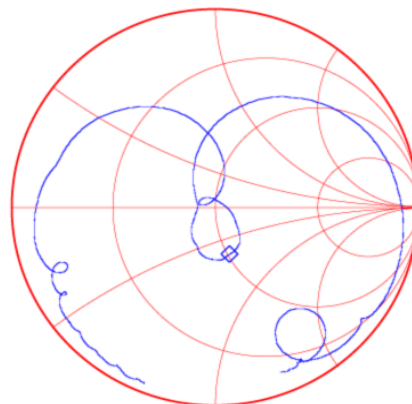
**Typical Performance (at +25°C)**



**Input Smith Chart**



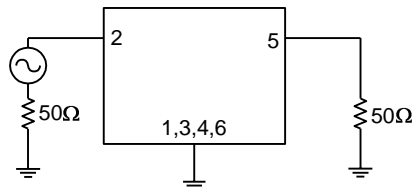
**Output Smith Chart**



**Matching Schematics**

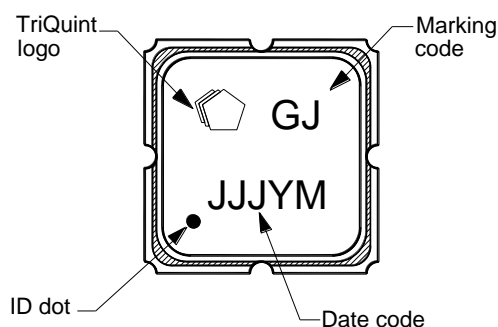
Actual matching values may vary due to PCB layout and parasitics

50 Ω  
Single-ended  
Input



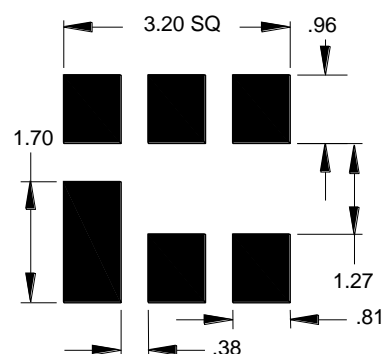
50 Ω  
Single-ended  
Output

**Marking**



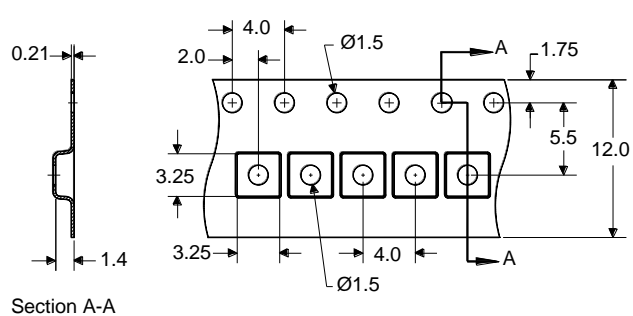
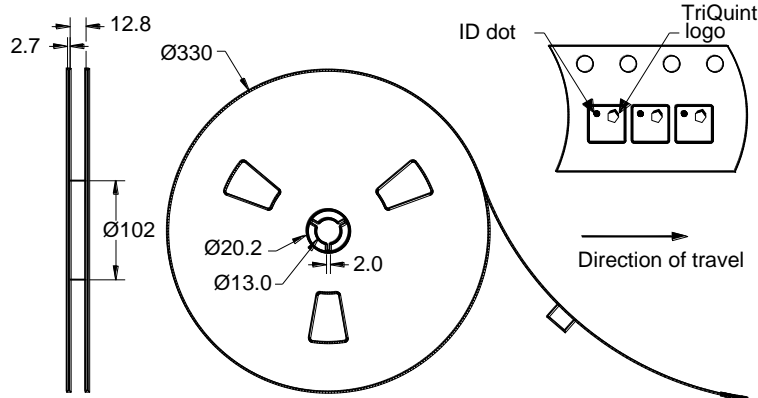
The date code consists of: day of the current year (Julian, 3 digits), Y = last digit of the year and M = manufacturing site code

**PCB Footprint**



This footprint represents a recommendation only  
Dimensions shown are nominal in millimeters

**Tape and Reel**




Dimensions shown are nominal in millimeters  
Packaging quantity: 5000 units/reel

### Maximum Ratings


Parameter	Symbol	Minimum	Maximum	Unit
Operating Temperature Range	T	-30	+85	°C
Storage Temperature Range	T <sub>stg</sub>	-40	+85	°C

### Important Notes

#### Warnings

- Electrostatic Sensitive Device (ESD) 
- Avoid ultrasonic exposure

#### RoHS Compliance

- This product complies with EU directive 2002/95/EC (RoHS) 

#### Solderability

- Compatible with JEDEC J-STD-020C **Pb**-free process, **260°C** peak reflow temperature

### Links to Additional Technical Information

[PCB Layout Tips](#)

[Qualification Flowchart](#)

[Soldering Profile](#)

[S-Parameters](#)

[RoHS Information](#)

[Other Technical Information](#)

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